







**DS90UB981-Q1** SNLS762 - FEBRUARY 2024

# DS90UB981-Q1 4K DSI to FPD-Link IV Bridge Serializer

# 1 Features

- Single or dual port MIPI DSI receiver
  - Compliant to D-PHY v1.2 and DSI v1.3.1
  - Packed 16/18/24/30-bit RGB and 16-bit YCbCr
  - Loosely packed 18-bit RGB and 20-bit 4:2:2
  - 1 clock lane and 1-4 configurable data lanes per D-PHY Port
  - Up to 2.5 Gbps/lane with skew calibration
  - Supports data lane swap and polarity inversion
  - Supports both burst and non-burst mode
  - SuperFrame Unpacking Capability
  - Suitable for 4K at 60Hz video resolution
- FPD-Link IV interface
  - Supports 10.8/6.75/3.375Gbps per channel; Up to 21.6Gbps over dual channels
  - Coax/STP interconnect support
  - Port Splitting to enable Y-cable interfaces
- Ultra-low latency control channel
  - Two I2C up to 1MHz (up to 3.4MHz for local bus access)
  - High speed GPIOs
- Backwards compatible
  - 720P 92x and 1080P/2K 94x product families
  - ADAS 936, 954, 960, 962, 9702, 9722 deserializers
- Security and diagnostics
  - Voltage and temperature monitoring
  - Line Fault Detection
  - BIST and pattern generation
  - CRC and error diagnostics
  - Unique ID for counterfeit protection
  - ECC on control bits
- Advanced link robustness and EMC control
  - Data scrambling
  - Spread spectrum clocking generation (SSCG)
- Low power operation
  - 1.8V and 1.1V dual power supply
- AEC-Q100 qualified for automotive applications
  - AEC-Q100 grade-level 2: -40°C to +105°C
  - 64 pin QFN Wettable flanks 9mm x 9mm
  - ISO 10605 and IEC 61000-4-2 ESD compliant

# 2 Applications

- Automotive displays:
  - Central Information Displays (CID)
  - Rear Seat Entertainment (RSE)
  - Digital instrument clusters
  - Head units and HMI modules
  - Head Up Display (HUD)
  - Rear view and side mirror displays

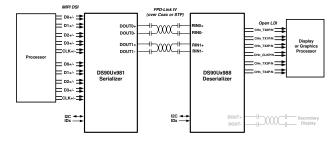
# 3 Description

DS90UB981-Q1 is a MIPI DSI to FPD-Link III/IV bridge device. In conjunction with an FPD-Link IV deserializer, the chipset provides a high-speed serialized interface over low-cost  $50\Omega$  coax or STP cables. The DS90UB981-Q1 is a D-PHY v1.2 compliant device that serializes a MIPI DSI input supporting video resolutions including 4K with 30-bit color depth. The FPD-Link IV interface supports video and audio data transmission and full duplex control, including I2C and GPIO data over a single channel or dual channels. Consolidation of video data and control over two FPD-Link IV lanes reduces the interconnect size and weight and simplifies system design. EMI is minimized by the use of low voltage differential signaling, data scrambling, SSCG, and randomization. In backward compatible mode, the devices supports up to 720p and 1080p resolutions with 24-bit color depth over a single/dual link. In ADAS compatible mode, the device is interoperable with 936, 95x, 96x & 97x deserializers supporting resolutions up to 8MP+/ 40fps.

# **Package Information**

PART NUMBER	PACKAGE (1)	PACKAGE SIZE <sup>(2)</sup>		
DS90UB981-Q1	RTD (VQFNP, 64)	9.00mm × 9.00mm		

- (1) For all available packages, see Section 6.
- The package size (length × width) is a nominal value and (2)includes pins, where applicable.



Simplified Application Diagram



# **Table of Contents**

1 Features1	4.2 Trademarks3
2 Applications1	4.3 Electrostatic Discharge Caution3
3 Description	
4 Device and Documentation Support3	
4.1 Documentation Support3	



# **4 Device and Documentation Support**

# 4.1 Documentation Support

#### 4.1.1 Related Documentation

For related documentation see the following:

- Texas Instruments, Soldering Specifications application note
- · Texas Instruments, Semiconductor and IC Package Thermal Metrics application note
- Texas Instruments, Leadless Leadframe Package (LLP) application note
- · Texas Instruments, LVDS Owner's Manual
- Texas Instruments, I2C Communication Over FPD-Link III with Bidirectional Control Channel application note
- Texas Instruments, Exploring the Internal Test Pattern Generation Feature of 720p FPD-Link III Devices application note
- Texas Instruments, I2C Bus Pullup Resistor Calculation application note
- Texas Instruments FPD-Link Learning Center, FPD-Link Fundamental Material video series
- Texas Instruments, Ten tips for successfully designing with automotive EMC/EMI requirements
- Texas Instruments, Serial Line-Fault Detection (Contact TI)

#### 4.2 Trademarks

All trademarks are the property of their respective owners.

# 4.3 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## 4.4 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

# 5 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

DATE	REVISION	NOTES				
February 2024	*	Initial Release				

SNLS762 - FEBRUARY 2024



# 6 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

Submit Document Feedback

Copyright © 2024 Texas Instruments Incorporated

www.ti.com 9-Nov-2025

#### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
	. ,	. ,			. ,	(4)	(5)		. ,
DS90UB981RTDRQ1	Active	Production	VQFN (RTD)   64	2000   LARGE T&R	Yes	NIPDAUAG	Level-3-260C-168 HR	-40 to 105	UB981
DS90UB981RTDRQ1.A	Active	Production	VQFN (RTD)   64	2000   LARGE T&R	Yes	NIPDAUAG	Level-3-260C-168 HR	-40 to 105	UB981
DS90UB981RTDTQ1	Active	Production	VQFN (RTD)   64	250   SMALL T&R	Yes	NIPDAUAG	Level-3-260C-168 HR	-40 to 105	UB981
DS90UB981RTDTQ1.A	Active	Production	VQFN (RTD)   64	250   SMALL T&R	Yes	NIPDAUAG	Level-3-260C-168 HR	-40 to 105	UB981

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 23-Sep-2025

# TAPE AND REEL INFORMATION



# TAPE DIMENSIONS KO PI BO BO Cavity AO

A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

	Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
ı	DS90UB981RTDRQ1	VQFN	RTD	64	2000	330.0	16.4	9.3	9.3	1.1	12.0	16.0	Q2

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 23-Sep-2025



### \*All dimensions are nominal

Ì	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
ı	DS90UB981RTDRQ1	VQFN	RTD	64	2000	367.0	367.0	38.0

# VQFNP - 0.9 mm max height PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale, TI's General Quality Guidelines, or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2025, Texas Instruments Incorporated

Last updated 10/2025